## **DSG-RICH R&D Meeting**

Date: May 3, 2021

Time: 11:00AM - 12:00PM

Attendees: Peter Bonneau, Aaron Brown, Pablo Campero, Brian Eng, George Jacobs,

Tyler Lemon, and Amrit Yegneswaran

## 1. SHT35 sensor PCB design submitted for fabrication

Peter Bonneau, Brian Eng, Tyler Lemon, and Marc McMullen

Waiting on information on where to ship SHT35 sensors for assembly

## 2. PRs submitted for interlock components

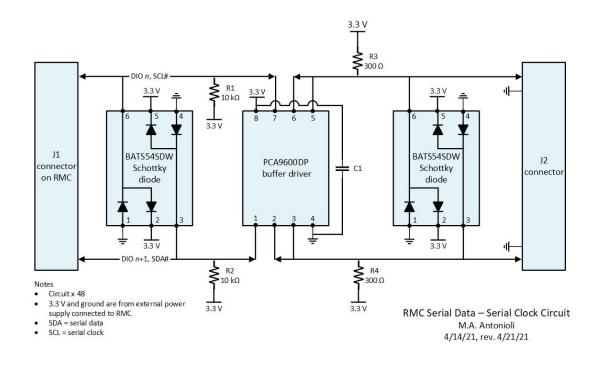
Tyler Lemon

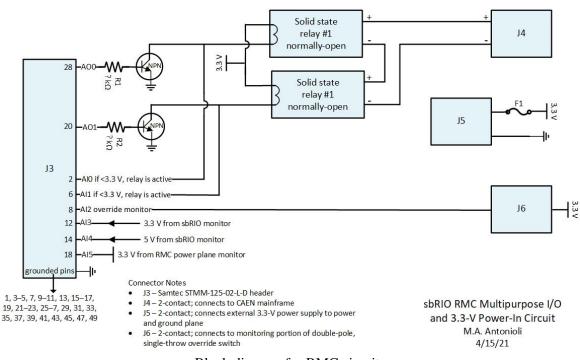
- PR # 402584 NI components
  - sbRIO-9629 development kit
    - Procured since it comes with a 12 VDC 6 A wall wart power supply with latching connector
  - Expansion chassis for gas system monitoring using C modules
  - DIN rail mount supplies for expansion chassis
  - Four NI-9219 universal input modules
    - Need three, one for spare
  - Two NI-9485 solid state relay (SSR) modules
    - Need one, one for spare
- PR # 402588P Hardware for prototyping interlock relay circuit on RMC
  - Two SSR types (different integrated circuit packages)
    - One type is DIP-8 (eight-pin, dual in-line package) with two internal relays
    - Other is SIP-4 (four-pin, single in-line package) with one internal relay
  - NPN bipolar junction transistors
    - Used as switches for external 3.3 V power to control relays that require higher power than sbRIO outputs are capable of
  - Prototyping hardware
    - DIP-8 socket adapter for SSRs
    - TSSOP-8 (eight-pin, thin-shrink, small outline package) to DIP-8 adapter for connecting NPN transistors to breadboard

## 3. RICH-II RIO Mezzanine Card (RMC)

Tyler Lemon and Marc McMullen

- Marc McMullen started designing schematic for RMC's 48 I<sup>2</sup>C circuits, interlock relay control, and sbRIO monitoring
- Tyler Lemon has procured prototyping components for RMC's interlock relay circuit





Block diagram for RMC circuits